



Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

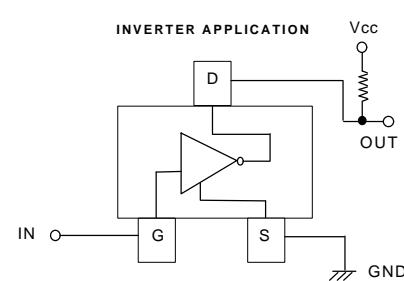
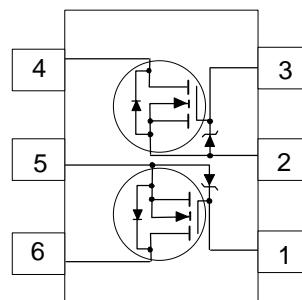
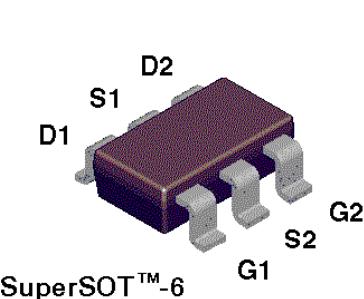
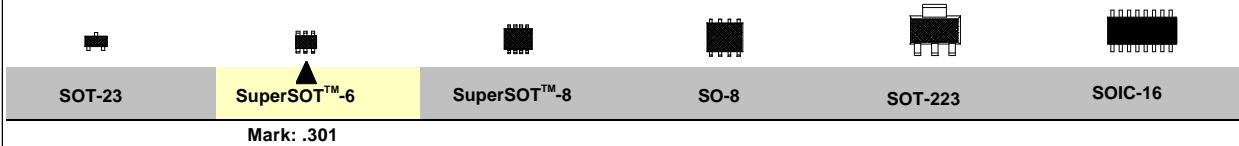
FDC6301N Dual N-Channel , Digital FET

General Description

These dual N-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors. Since bias resistors are not required, these N-Channel FET's can replace several digital transistors, with a variety of bias resistors.

Features

- 25 V, 0.22 A continuous, 0.5 A Peak.
 $R_{DS(ON)} = 5 \Omega @ V_{GS} = 2.7 \text{ V}$
 $R_{DS(ON)} = 4 \Omega @ V_{GS} = 4.5 \text{ V}$
- Very low level gate drive requirements allowing direct operation in 3V circuits. $V_{GS(th)} < 1.5 \text{ V}$.
- Gate-Source Zener for ESD ruggedness.
 $>6\text{kV}$ Human Body Model.



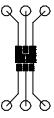
Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | FDC6301N | Units |
|-------------------|---|------------|-------|
| V_{DSS}, V_{CC} | Drain-Source Voltage, Power Supply Voltage | 25 | V |
| V_{GSS}, V_{IN} | Gate-Source Voltage, V_{IN} | -0.5 to +8 | V |
| I_D, I_{OUT} | Drain/Output Current - Continuous | 0.22 | A |
| | - Pulsed | 0.5 | |
| P_D | Maximum Power Dissipation (Note 1a) | 0.9 | W |
| | (Note 1b) | 0.7 | |
| T_J, T_{STG} | Operating and Storage Temperature Range | -55 to 150 | °C |
| ESD | Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm) | 6.0 | kV |

THERMAL CHARACTERISTICS

| | | | |
|-----------|---|-----|------|
| R_{QJA} | Thermal Resistance, Junction-to-Ambient (Note 1a) | 140 | °C/W |
| R_{QJC} | Thermal Resistance, Junction-to-Case (Note 1) | 60 | °C/W |

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|--|---|---|------|------|-----|----------------------------|
| OFF CHARACTERISTICS | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0\text{ V}$, $I_D = 250\text{ }\mu\text{A}$ | 25 | | | V |
| $\Delta BV_{DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient | $I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C | | 25 | | $\text{mV}/^\circ\text{C}$ |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 20\text{ V}$, $V_{GS} = 0\text{ V}$ $T_J = 55^\circ\text{C}$ | | | 1 | μA |
| I_{GSS} | Gate - Body Leakage Current | $V_{GS} = 8\text{ V}$, $V_{DS} = 0\text{ V}$ | | | 10 | μA |
| ON CHARACTERISTICS (Note 2) | | | | | | |
| $\Delta V_{GS(\text{th})}/\Delta T_J$ | Gate Threshold Voltage Temp.Coefficient | $I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C | | -2.1 | | $\text{mV}/^\circ\text{C}$ |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$ | 0.65 | 0.85 | 1.5 | V |
| $R_{DS(\text{ON})}$ | Static Drain-Source On-Resistance | $V_{GS} = 2.7\text{ V}$, $I_D = 0.2\text{ A}$ | | 3.8 | 5 | Ω |
| | | $T_J = 125^\circ\text{C}$ | | 6.3 | 9 | |
| | | $V_{GS} = 4.5\text{ V}$, $I_D = 0.4\text{ A}$ | | 3.1 | 4 | |
| $I_{D(\text{ON})}$ | On-State Drain Current | $V_{GS} = 2.7\text{ V}$, $V_{DS} = 5\text{ V}$ | 0.2 | | | A |
| g_{FS} | Forward Transconductance | $V_{DS} = 5\text{ V}$, $I_D = 0.4\text{ A}$ | | 0.25 | | S |
| DYNAMIC CHARACTERISTICS | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = 10\text{ V}$, $V_{GS} = 0\text{ V}$, $f = 1.0\text{ MHz}$ | | 9.5 | | pF |
| C_{oss} | Output Capacitance | | | 6 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 1.3 | | pF |
| SWITCHING CHARACTERISTICS (Note 2) | | | | | | |
| $t_{D(\text{on})}$ | Turn - On Delay Time | $V_{DD} = 6\text{ V}$, $I_D = 0.5\text{ A}$, $V_{GS} = 4.5\text{ V}$, $R_{\text{GEN}} = 50\Omega$ | | 5 | 10 | ns |
| t_r | Turn - On Rise Time | | | 4.5 | 10 | ns |
| $t_{D(\text{off})}$ | Turn - Off Delay Time | | | 4 | 8 | ns |
| t_f | Turn - Off Fall Time | | | 3.2 | 7 | ns |
| Q_g | Total Gate Charge | $V_{DS} = 5\text{ V}$, $I_D = 0.2\text{ A}$, $V_{GS} = 4.5\text{ V}$ | | 0.49 | 0.7 | nC |
| Q_{gs} | Gate-Source Charge | | | 0.22 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 0.07 | | nC |
| Inverter Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted) | | | | | | |
| $I_{O(\text{off})}$ | Zero Input Voltage Output Current | $V_{CC} = 20\text{ V}$, $V_i = 0\text{ V}$ | | | 1 | μA |
| $V_{I(\text{off})}$ | Input Voltage | $V_{CC} = 5\text{ V}$, $I_O = 10\text{ }\mu\text{A}$ | | | 0.5 | V |
| $V_{I(\text{on})}$ | | $V_O = 0.3\text{ V}$, $I_O = 0.005\text{ A}$ | 1 | | | V |
| $R_{O(\text{on})}$ | Output to Ground Resistance | $V_i = 2.7\text{ V}$, $I_O = 0.2\text{ A}$ | | 3.8 | 5 | Ω |
| Notes: | | | | | | |
| 1. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJA} is guaranteed by design while R_{BCA} is determined by the user's board design. R_{BJA} shown below for single device operation on FR-4 in still air. | | | | | | |
|  <p>a. 140°C/W on a 0.125 in² pad of 2oz copper.</p>  <p>b. 180°C/W on a 0.005 in² of pad of 2oz copper.</p> | | | | | | |
| 2. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2.0\%$. | | | | | | |

Typical Electrical Characteristics

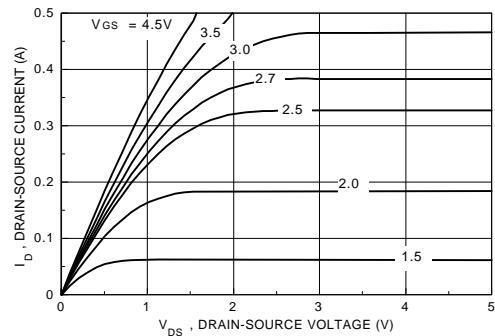


Figure 1. On-Region Characteristics.

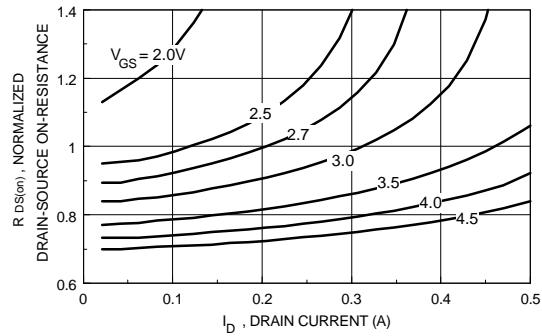


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

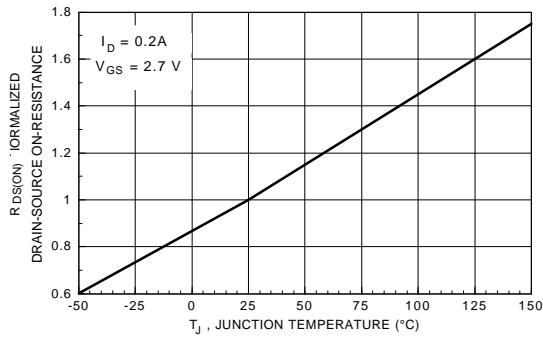


Figure 3. On-Resistance Variation with Temperature.

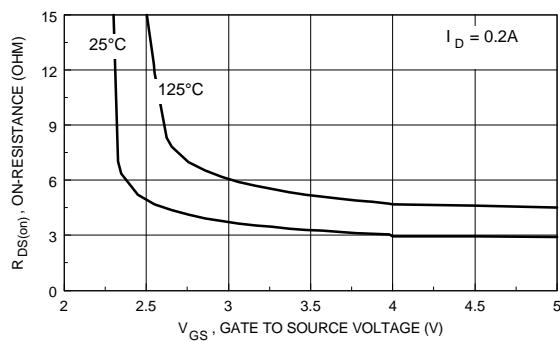


Figure 4. On Resistance Variation with Gate-To-Source Voltage.

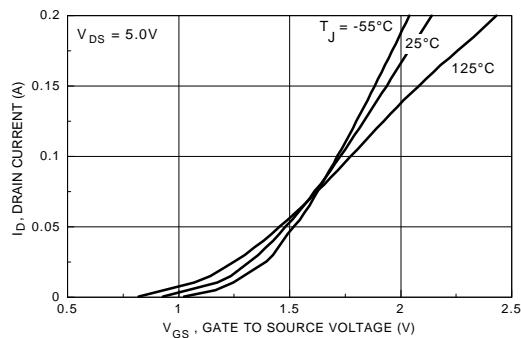


Figure 5. Transfer Characteristics.

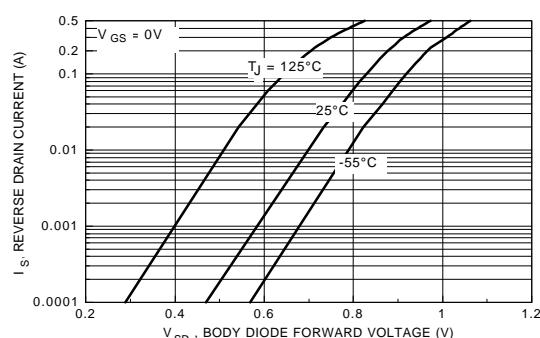


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

Typical Electrical Characteristics (continued)

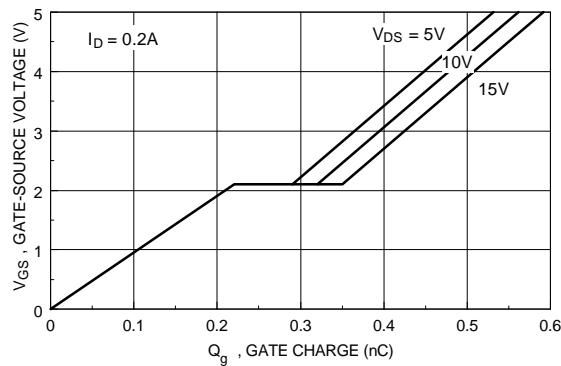


Figure 7. Gate Charge Characteristics.

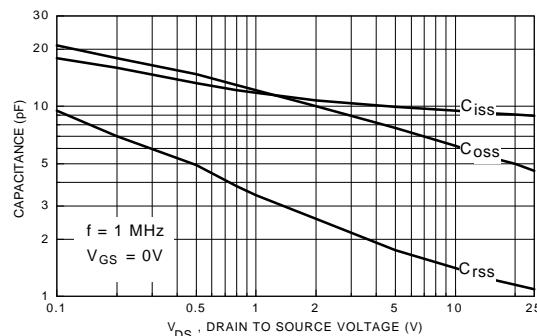


Figure 8. Capacitance Characteristics.

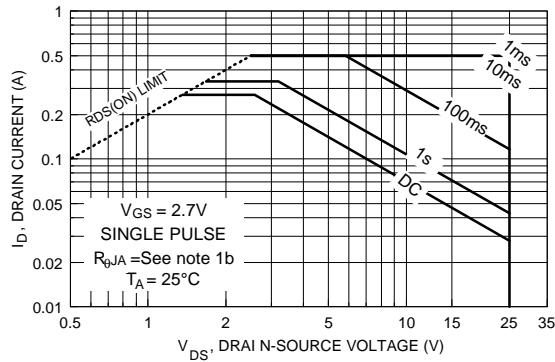


Figure 9. Maximum Safe Operating Area.

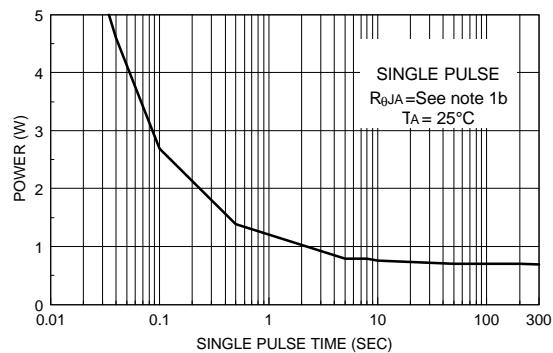


Figure 10. Single Pulse Maximum Power Dissipation.

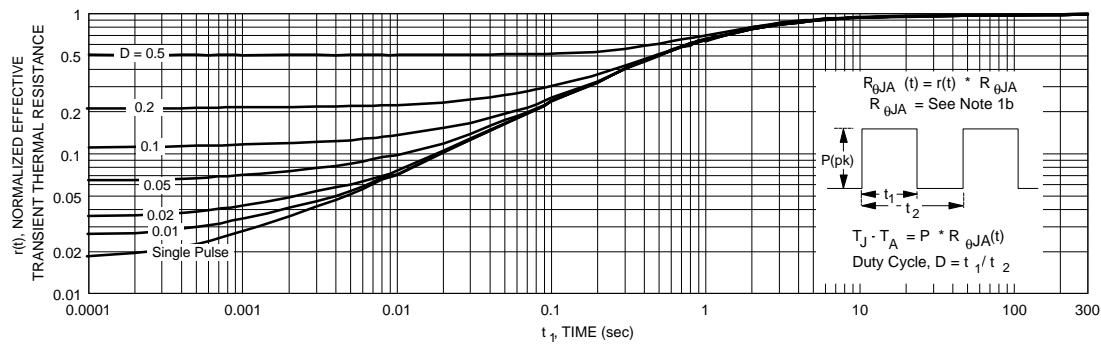


Figure 11. Transient Thermal Response Curve.

Note: Thermal characterization performed using the conditions described in note 1b. Transient thermal response will change depending on the circuit board design.

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

| | | | | |
|----------------------------------|---------------------------------|---------------------------------|------------------------------|-----------------------|
| ACE TM | FAST [®] | MICROWIRE [™] | SILENT SWITCHER [®] | UHC [™] |
| Bottomless [™] | FAST ^r [™] | OPTOLOGIC [®] | SMART START [™] | UltraFET [®] |
| CoolFET [™] | FRFET [™] | OPTOPLANAR [™] | SPM [™] | VCX [™] |
| CROSSVOLT [™] | GlobalOptoisolator [™] | PACMAN [™] | STAR*POWER [™] | |
| DenseTrench [™] | GTO [™] | POP [™] | Stealth [™] | |
| DOME [™] | HiSeC [™] | Power247 [™] | SuperSOT [™] -3 | |
| EcoSPARK [™] | I ² C [™] | PowerTrench [®] | SuperSOT [™] -6 | |
| E ² CMOS [™] | ISOPLANAR [™] | QFET [™] | SuperSOT [™] -8 | |
| EnSign [™] | LittleFET [™] | QS [™] | SyncFET [™] | |
| FACT [™] | MicroFET [™] | QT Optoelectronics [™] | TinyLogic [™] | |
| FACT Quiet Series [™] | MicroPak [™] | Quiet Series [™] | TruTranslation [™] | |

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

| Datasheet Identification | Product Status | Definition |
|--------------------------|------------------------|---|
| Advance Information | Formative or In Design | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| No Identification Needed | Full Production | This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design. |
| Obsolete | Not In Production | This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only. |

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor
19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free
USA/Canada

Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local
Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[ON Semiconductor](#):

[FDC6301N](#)



OCEAN CHIPS

Океан Электроники

Поставка электронных компонентов

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибутором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибутором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А